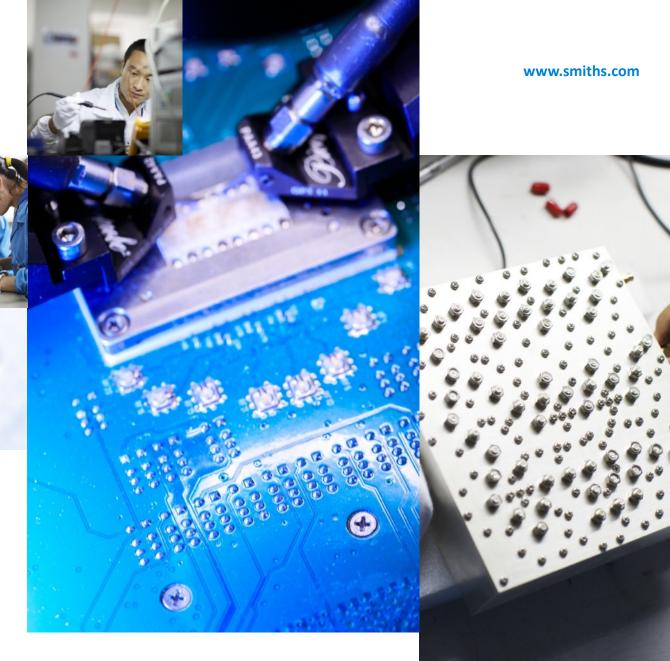
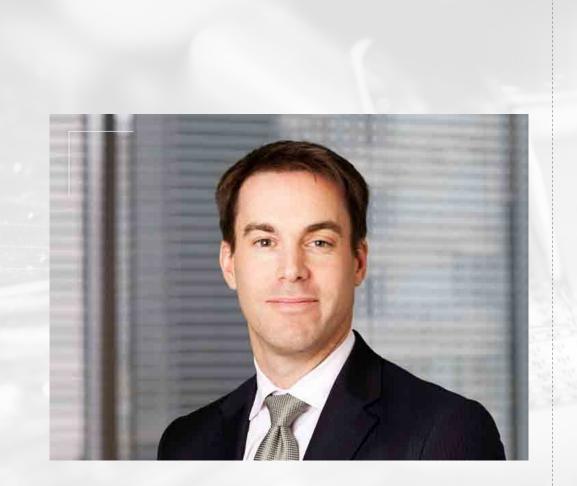
smiths interconnect

SMITHS INTERCONNECT

CAPITAL MARKETS EVENT – 17 NOVEMBER 2021





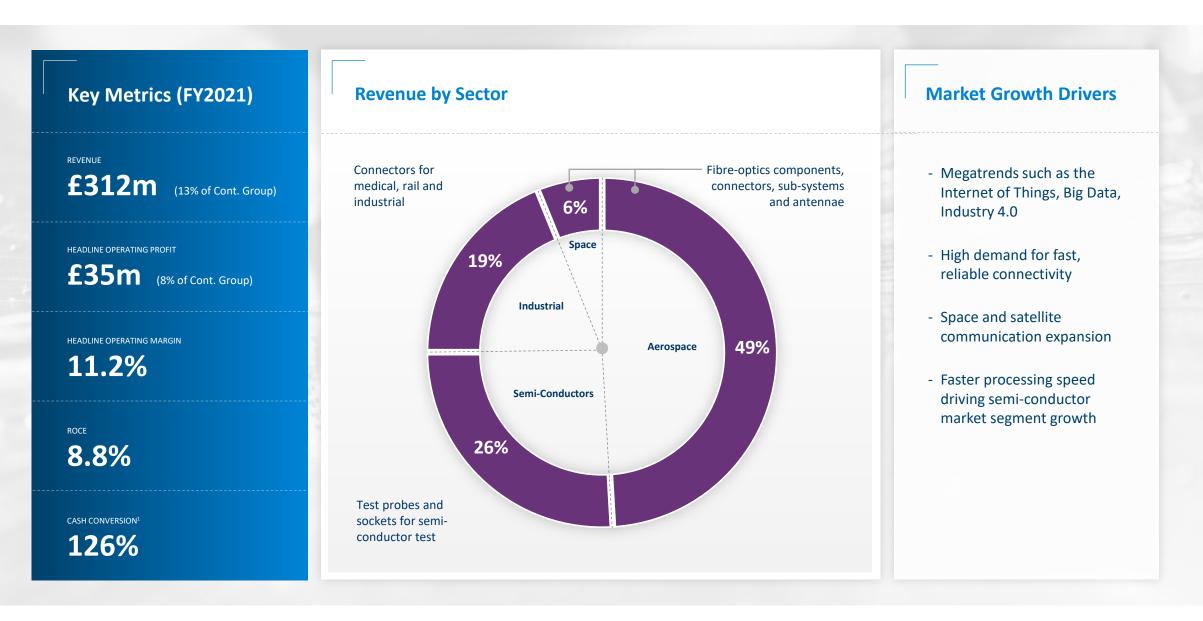
PRESIDENT SMITHS INTERCONNECT

JULIAN FAGGE

Executive summary



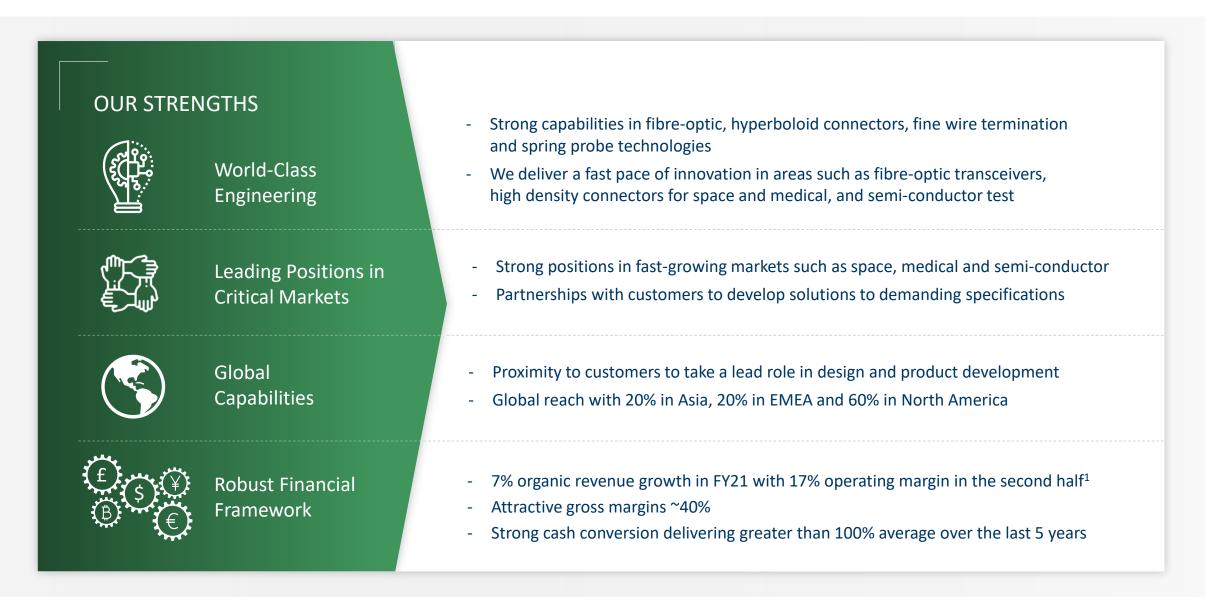
Smiths Interconnect: cutting-edge connectivity



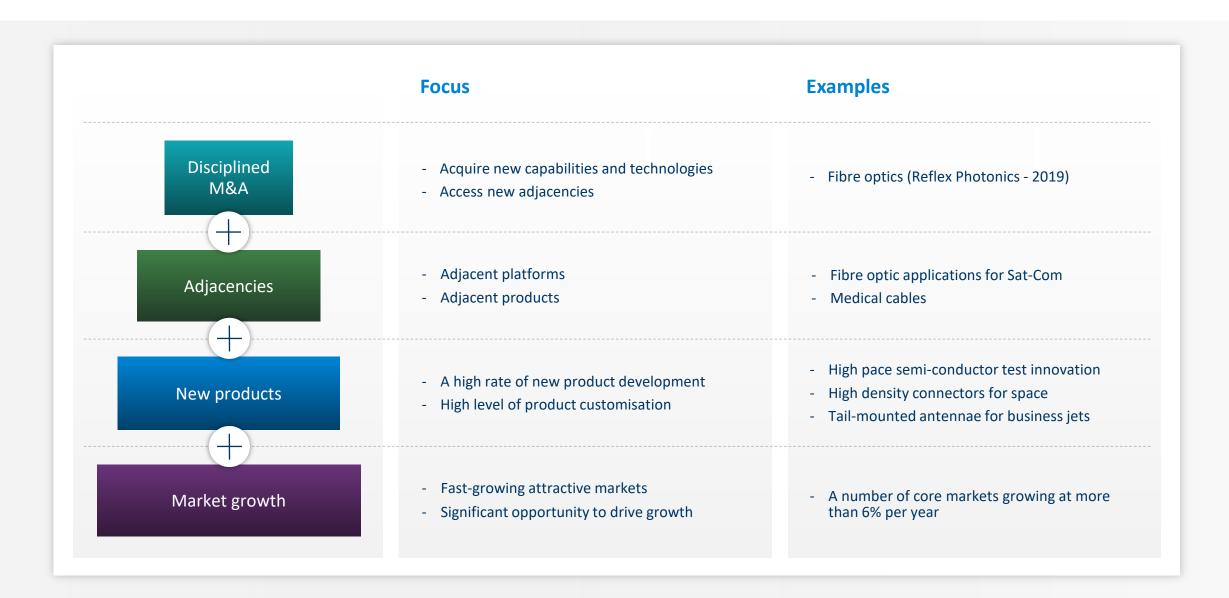
Smiths Value Engine

OUR PURPOSE	OUR STREE	NGTHS	OUR PRIORITIES
		World-Class Engineering	Growth
		Leading Positions in Critical Markets	Execution
PIONEERS OF PROGRESS		Global Capabilities	
Improving our world through smarter engineering	€ B €	Robust Financial Framework	People

Smiths Interconnect: fundamental strengths

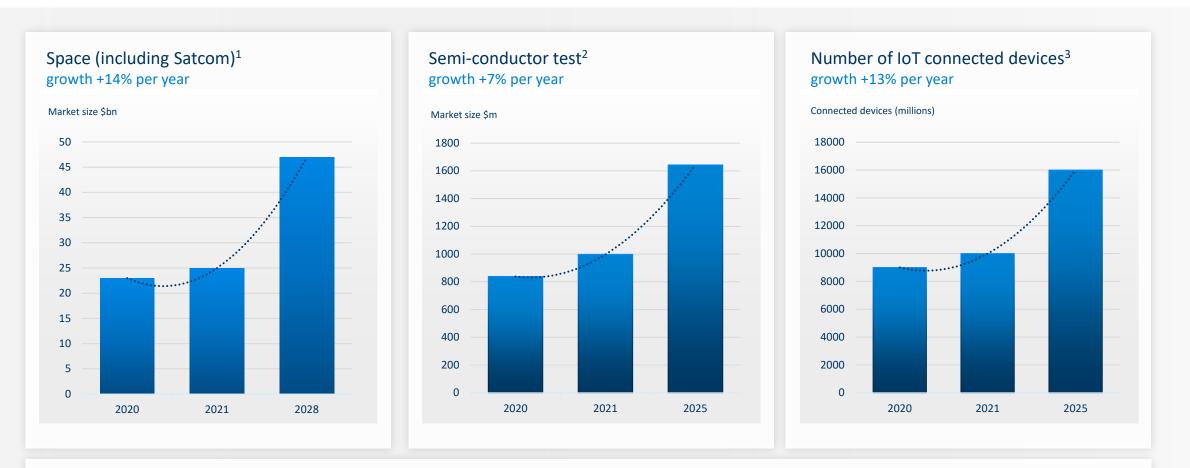


How Smiths Interconnect accelerates growth



MARKET GROWTH

Accelerating growth in our core markets



- Space (+14%) growing fast behind LEO and GEO satellite launches driven by growing demand for data and connectivity
- Aerospace & defence (+5%) growth coming from the return of commercial aerospace and continuation of major defence programmes
- Semi-conductor test (+7%) strong growth in semi-conductor driving strong demand for test sockets and probes
- Industrial (+5%) good growth expected from rail and medical markets as global consumption increases

New products



Products are optimised for speed, weight and power

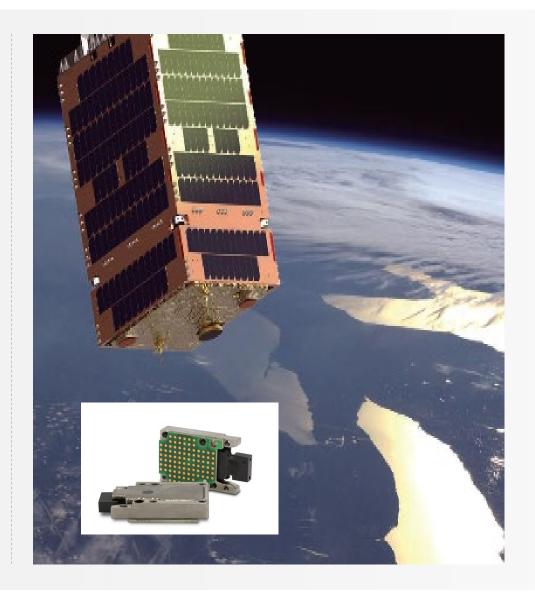
Adjacencies: New fibre optic products for fast growing satellite communications

Market: Space (growth +14% per year)

Application: Satellite communication

- Next generation satellites need to communicate faster and handle more data as global demand for connectivity increases
- We have a range of products including radio frequency components, filters, robust connectors interposers and optical transceivers
- Our products are small and lightweight, and able to operate in the harsh environment of space
- Our optical transceiver technology enables communication speeds and data rates to triple from ~10 to ~28 gigabytes/second
- This demand for speed will increase with future generation satellites anticipating demand up to 50gb/s. These speeds require fibre-optic technologies

Strong demand from customers for our products and innovation partnership on next generation satellites

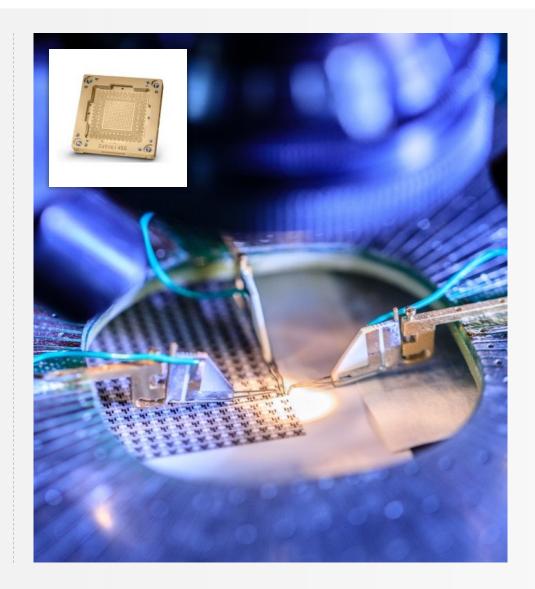


New Products: semi-conductor test

Market: Semi-conductor Test (growth +7% per year)

Applications: Chips for gaming, computing, IoT etc.

- Next generation technologies such as 5G, artificial intelligence, deep cognitive learning, vehicle-to-vehicle communication and self-driving vehicles are driving demand for high-speed semi-conductors, data transfer and processing technologies
- Smiths Interconnect designs and manufacturers advanced test socket solutions used to test the most advanced semi-conductor chips
- Smiths Interconnect's test sockets provide high-performance, high-reliability testing of the integrated circuits
- The DaVinci[™] series utilises specialised engineering to allow reliable testing of high frequency signals for the fastest and smallest semi-conductor chips
- The next generation of DaVinci[™] products currently under development allow testing of even smaller higher density chip technology



New Products: aviation communication

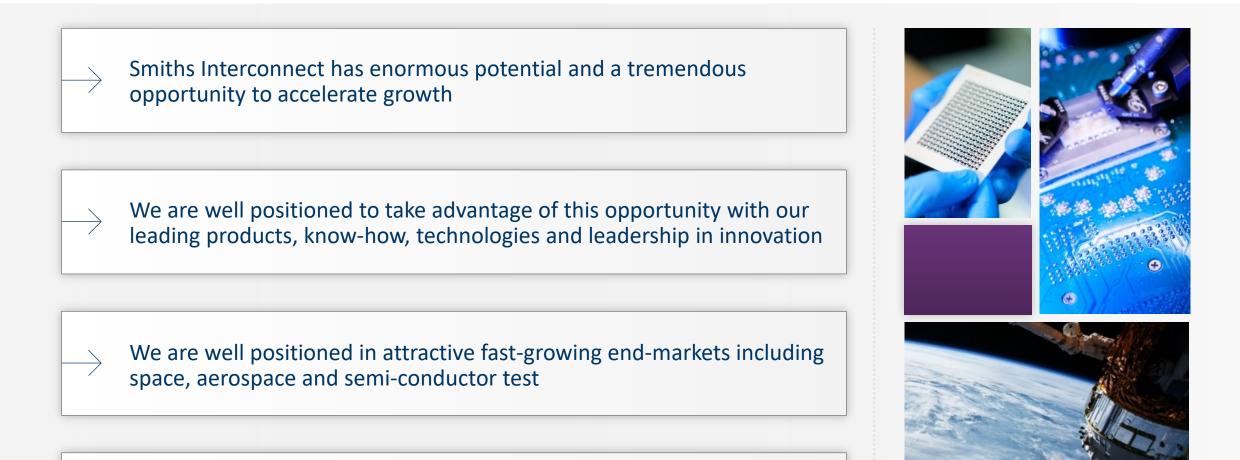
Market: Aviation communication (growth +5% per year)

End-application: Antennae for Satellite Communication

- The fast-growing business jet market is stimulating demand for advanced onboard antenna units
- Size, weight and power is critical as the antenna unit needs to be small, light weight yet extremely robust
- We have launched a lightweight antenna system to be used in tail-mount installations combining the radio frequency electronics, antenna aperture and positioning system in a single unit
- Antenna provides always-available, reliable, secure connectivity, anytime and anywhere
- The system has been validated by the Federal Aviation Administration and has received Inmarsat approval for use over the Inmarsat Global Xpress Kaband network

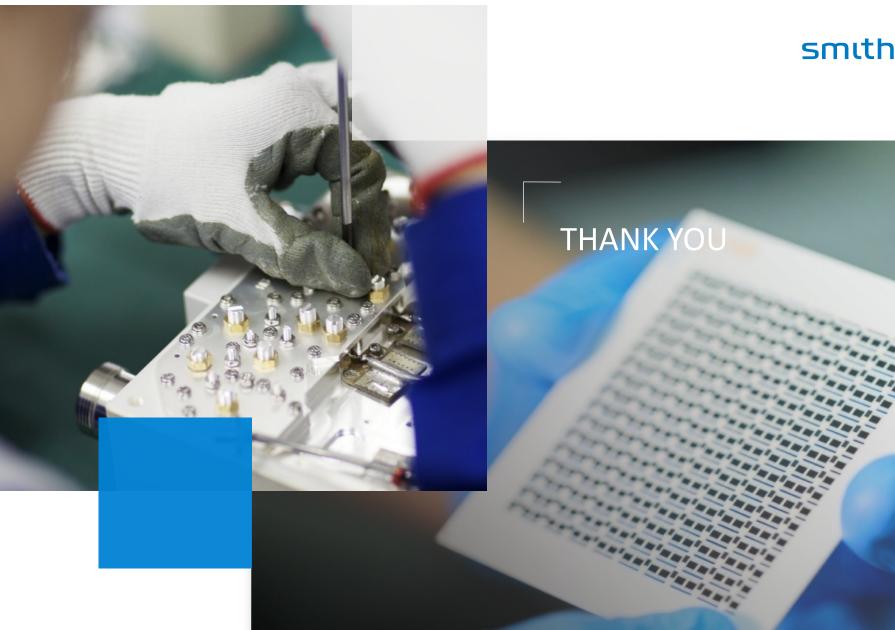


Smiths Interconnect: Closing Remarks



We have the capability and the talent to execute





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